Never stop thinking

IFX21401

Low Dropout Voltage Tracking Regulator

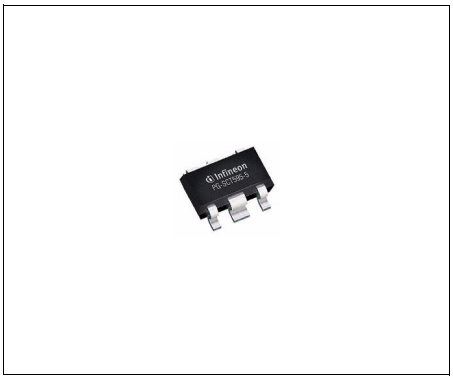
IFX21401MB

Data Sheet

Rev. 1.01, 2009-10-19

Standard Power

1 Overview



PG-SCT595-5

Features

- 50 mA Output Current Capability
- Tiny and Thermally Enhanced-Package
- Accurate Output Voltage Tracking
- Stable with Small Output Capacitor
- Low Dropout Voltage, 300mV
- Combined Reference / Enable Input
- Low Current Consumption in Stand-by Mode
- Maximum Input Voltage -42 V ≤ V_I ≤ +45 V
- Reverse Polarity Protection
- Output Short Circuit to Ground and Supply Protection
- Overtemperature Protection
- Temperature Range -40 °C ≤ T_j ≤ 125 °C
- Green Product (RoHS compliant)

Applications

- Manufacturing Automation
- Appliances
- HDTV Televisions
- Game Consoles
- Network Routers

For automotive and transportation applications, please refer to the Infineon TLE and TLF voltage regulator series.

Functional Description

The IFX21401 is a monolithic integrated low dropout voltage tracker in a tiny SMD package PG-SCT595-5 with excellent thermal resistance. It is designed to supply off-board loads (e.g. sensors) in harsh environments. The IC protects itself in case of overload, overtemperature, reverse polarity as well as output short circuit to battery or ground.

Supply voltages up to V_I = 45 V are regulated to a reference voltage applied at the adjust input “ADJ” with high accuracy. The output “Q” is able to drive loads up to 50 mA.

In order to reduce the quiescent current to a minimum, the IFX21401 can be switched to stand-by mode by setting the adjust/enable input “ADJ/EN” to “low”.

Type	Package	Marking
IFX21401MB	PG-SCT595-5	T1

2 Block Diagram

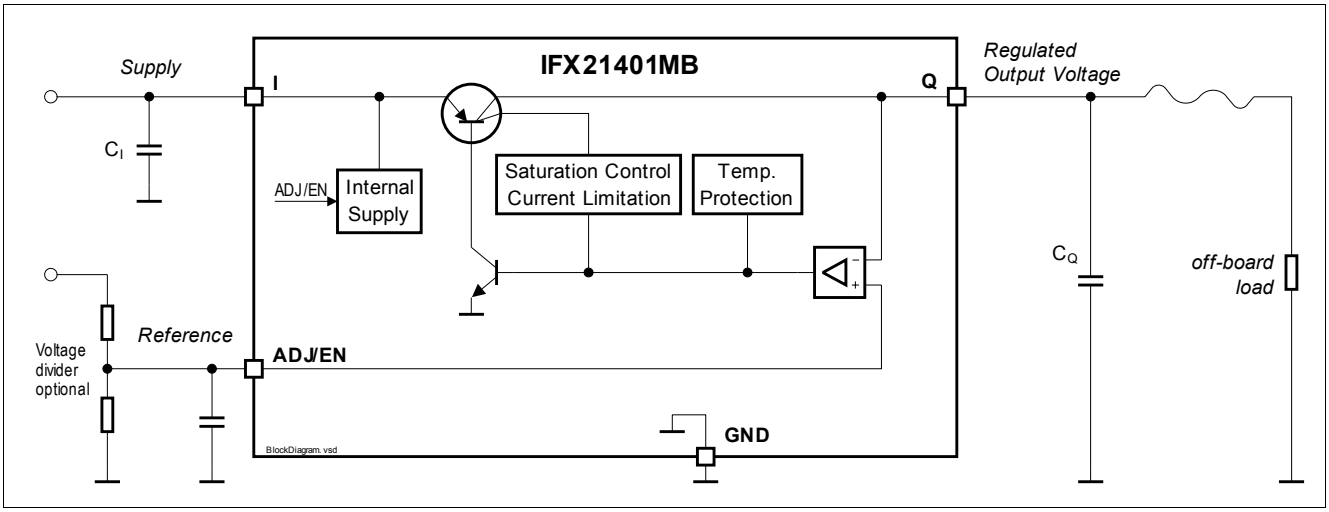


Figure 1 Block Diagram and Typical Application Circuit

3 Pin Configuration

3.1 Pin Assignment

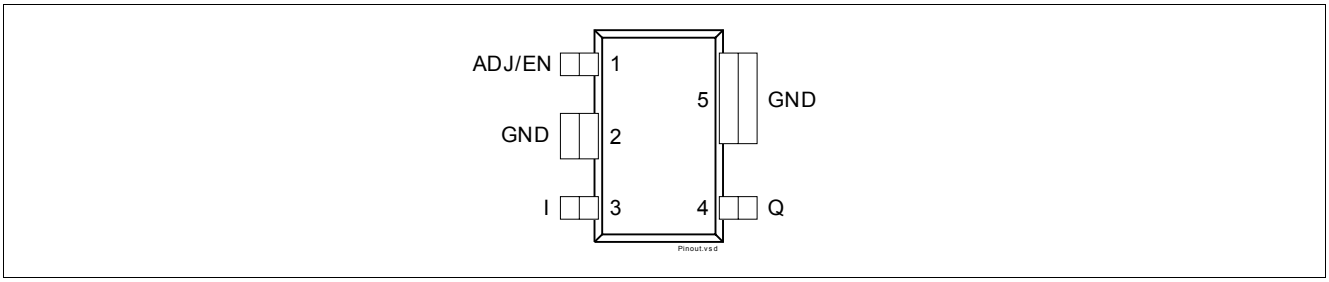


Figure 2 Pin Configuration Package PG-SCT595-5

3.2 Pin Definitions and Functions

Pin	Symbol	Function
1	ADJ/EN	**Adjust / Enable.** Connect the reference to this pin. A low signal disables the IC; a high signal switches it on. The reference voltage can be connected directly or by a voltage divider for lower output voltages. For compensating line influences, a capacitor close to the IC pins is recommended.
2	GND	**Ground Reference.** Internally connected to Pin 5. Connect to heatsink area.
3	I	**Input.** IC supply. For compensating line influences, a capacitor close to the IC pins is recommended.
4	Q	**Tracker Output.** Block to GND with a capacitor close to the IC terminals, respecting capacitance and ESR requirements given in the table “Functional Range”.
5	GND	**Ground Reference.** Internally connected to Pin 2. Connect to heatsink area.

4 General Product Characteristics

4.1 Absolute Maximum Ratings

Absolute Maximum Ratings [1)]

-40 °C ≤ T_j ≤ 150 °C; all voltages with respect to ground (unless otherwise specified).

Pos.	Parameter	Symbol	Limit Values		Unit	Conditions
			Min.	Max.		
Voltages						
4.1.1	Input voltage	V_I	-42	45	V	–
4.1.2	Output voltage	V_Q	-1	40	V	–
4.1.3	Adjust / Enable Input	$V_{ADJ/EN}$	-0.3	40	V	–
Temperatures						
4.1.4	Junction Temperature	T_j	-40	150	°C	–
4.1.5	Storage Temperature	T_{stg}	-50	150	°C	–
ESD Susceptibility						
4.1.6	ESD Resistivity	$V_{ESD,HBM}$	-3	3	kV	HBM[2)]
4.1.7		$V_{ESD,CDM}$	-2	2	kV	CDM[3)]

1) Not subject to production test, specified by design.

2) ESD susceptibility, Human Body Model “HBM” according to EIA/JESD 22-A114B

3) ESD susceptibility, Charged Device Model “CDM” according to EIA/JESD22-C101 or ESDA STM5.3.1

Note: Stresses above the ones listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note: Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as “outside” normal operating range. Protection functions are not designed for continuous repetitive operation.

4.2 Functional Range

Pos.	Parameter	Symbol	Limit Values		Unit	Conditions
			Min.	Max.		
4.2.1	Input Voltage	V_I	4	40	V	–
4.2.1	Adjust / Enable Input Voltage (Voltage Tracking Range)	$V_{ADJ/EN}$	2.5	36	V	–
4.2.2	Junction Temperature	T_j	-40	125	°C	–
4.2.3	Output Capacitor Requirements	C_Q	1	–	µF	– 1)
4.2.4		ESR_{CQ}	–	3	Ω	– 2)

1) The minimum output capacitance requirement is applicable for a worst case capacitance tolerance of 30%

2) relevant ESR value at f = 10 kHz

Note: Within the functional range the IC operates as described in the circuit description. The electrical characteristics are specified within the conditions given in the related electrical characteristics table.

4.3 Thermal Resistance

Pos.	Parameter	Symbol	Limit Value			Unit	Conditions
			Min.	Typ.	Max.		
4.3.5	Junction to Ambient	R_{thJA}	–	81	–	K/W	2s2p board[1)]
4.3.1			–	217	–	K/W	Footprint only[2)]
4.3.2			–	117	–	K/W	300 mm^2 PCB heatsink area[2)]
4.3.3			–	103	–	K/W	600 mm^2 PCB heatsink area[2)]
4.3.4	Junction to Soldering Point	R_{thJSP}	–	30	–	K/W	Pins 2, 5 fixed to T_A

1) Specified R_{thJA} value is according to JESD51-2,-5,-7 at natural convection on FR4 2s2p board; The product (chip+package) was simulated on a 76.2 x 114.3 x 1.5 mm board with 2 inner copper layers (2 x 70µm Cu, 2 x 35µm Cu). Where applicable a thermal via array under the package contacted the first inner copper layer.

2) Package mounted on PCB FR4; 80 x 80 x 1.5 mm; 35 µm Cu, 5 µm Sn; horizontal position; zero airflow. Not subject to production test; specified by design.

5 Electrical Characteristics

5.1 Tracking Regulator

The output voltage V_Q is controlled by comparing it to the voltage applied at pin ADJ/EN and driving a PNP pass transistor accordingly. The control loop stability depends on the output capacitor C_Q, the load current, the chip temperature and the poles/zeros introduced by the integrated circuit. To ensure stable operation, the output capacitor's capacitance and its equivalent series resistor ESR requirements given in the table "Functional Range" have to be maintained. For details see also the typical performance graph "Output Capacitor Series Resistor ESR_{CQ} vs. Output Current I_Q". Also, the output capacitor shall be sized to buffer load transients.

An input capacitor C_I is recommended to buffer line influences. Connect the capacitors close to the IC terminals.

Protection circuitry prevent the IC as well as the application from destruction in case of catastrophic events. These safeguards contain output current limitation, reverse polarity protection as well as thermal shutdown in case of overtemperature.

In order to avoid excessive power dissipation beyond the capability of the pass element and the package, the maximum output current is decreased at high input voltages.

The overtemperature protection circuit prevents the IC from immediate destruction under fault conditions (e. g. output continuously short-circuited) by reducing the output current. Please note that a junction temperature above 150 °C is outside the maximum ratings and reduces the IC lifetime.

The IFX21401 is protected from a reverse (i.e. negative polarity) input voltage. During reverse input voltage there is a small of current flowing into the IC and thermal shutdown protection is not operating. For reverse current details refer to the electrical characteristics table and typical performance graphs.

Table 1 Electrical Characteristics Tracking Regulator

V_I = 13.5 V; $V_{ADJ/EN} \geq$ 2.5 V; -40 °C ≤ T_j ≤ 125 °C; all voltages with respect to ground (unless otherwise specified).

Pos.	Parameter	Symbol	Limit Values			Unit	Conditions
			Min.	Typ.	Max.		
5.1.1	Output Voltage Tracking Accuracy	ΔV_Q	-5	–	5	mV	1 mA ≤ I_Q ≤ 10 mA; 6 V ≤ V_I ≤ 16 V
5.1.2			-25	–	25	mV	1 mA ≤ I_Q ≤ 50 mA; 6 V ≤ V_I ≤ 28 V
5.1.3			-25	–	25	mV	1 mA ≤ I_Q ≤ 10 mA; 6 V ≤ V_I ≤ 40V
5.1.4	Load Regulation steady-state	$\lvert dV_{Q,load} \rvert$	–	–	15	mV	I_Q = 1 mA to 30 mA;
5.1.5	Line Regulation steady-state	$\lvert dV_{Q,line} \rvert$	–	–	10	mV	V_I = 6 V to 40 V; I_Q = 10 mA
5.1.6	Power Supply Ripple Rejection	$PSRR$	–	48	–	dB	f_{ripple} = 100 Hz; V_{ripple} = 1 Vpp [1]
5.1.7	Dropout Voltage $V_{dr} = V_I - V_Q$	V_{dr}	–	100	300	mV	I_Q = 10 mA $V_{ADJ} \geq$ 4 V [2]
5.1.8	Output Current Limitation	$I_{Q,max}$	51	85	120	mA	V_Q = (V_{ADJ} - 0.1 V)

Table 1 Electrical Characteristics Tracking Regulator

V_I = 13.5 V; $V_{ADJ/EN} \geq$ 2.5 V; -40 °C ≤ T_j ≤ 125 °C; all voltages with respect to ground (unless otherwise specified).

Pos.	Parameter	Symbol	Limit Values			Unit	Conditions
			Min.	Typ.	Max.		
5.1.9	Reverse Current	I_Q	-5	-1	–	mA	V_I = 0 V; V_Q = 16 V; V_{ADJ} = 5 V
5.1.10	Reverse Current at Negative Input Voltage	I_I	-10	-2	–	mA	V_I = -16 V; V_Q = 0 V; V_{ADJ} = 5 V
Overtemperature Protection:							
5.1.11	Junction Temperature Equilibrium	$T_{j,eq}$	151	–	200	°C	T_j increasing due to power dissipation generated by the IC 1)

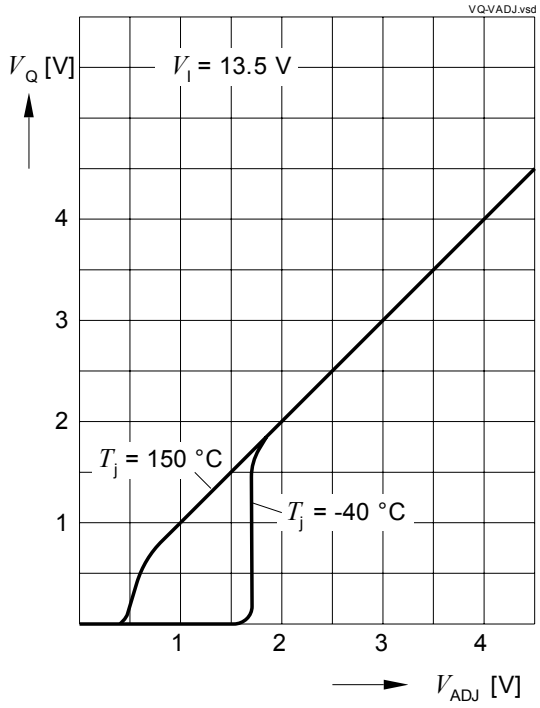
1) Parameter not subject to production test; specified by design.

2) Measured when the output voltage V_Q has dropped 100 mV from its nominal value.

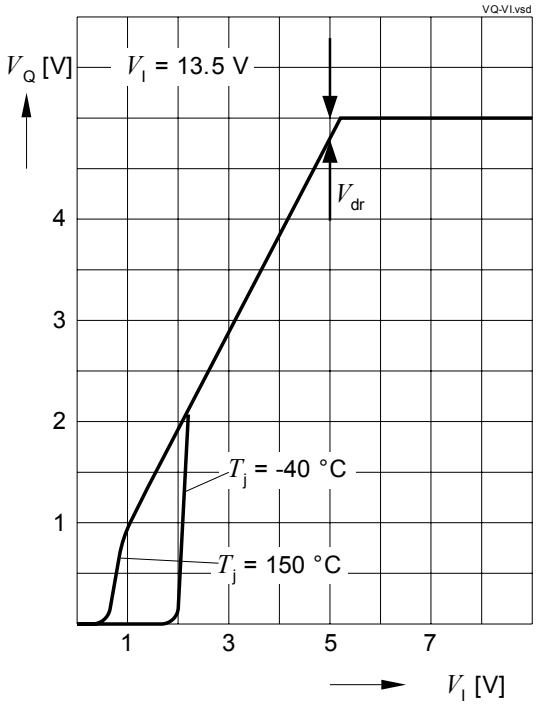
Typical Performance Characteristics Tracking Regulator

$V_{ADJ/EN}$ = 5 V (unless otherwise noted)

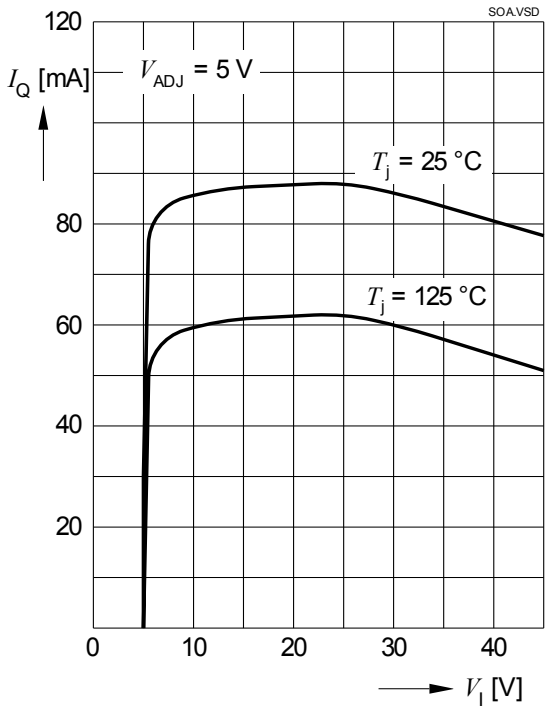
**Output Voltage V_Q vs.
Adjust Voltage V_{ADJ}**



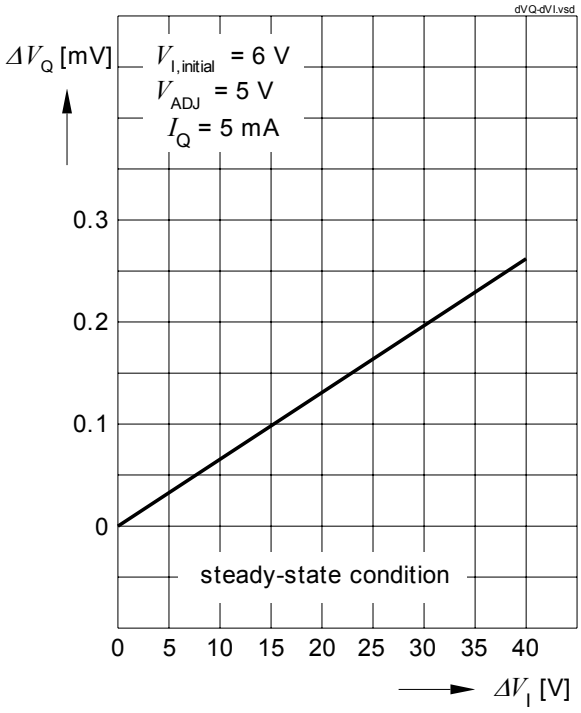
**Output Voltage V_Q vs.
Input Voltage V_I**



**Maximum Output Current I_Q vs.
Input Voltage V_I**



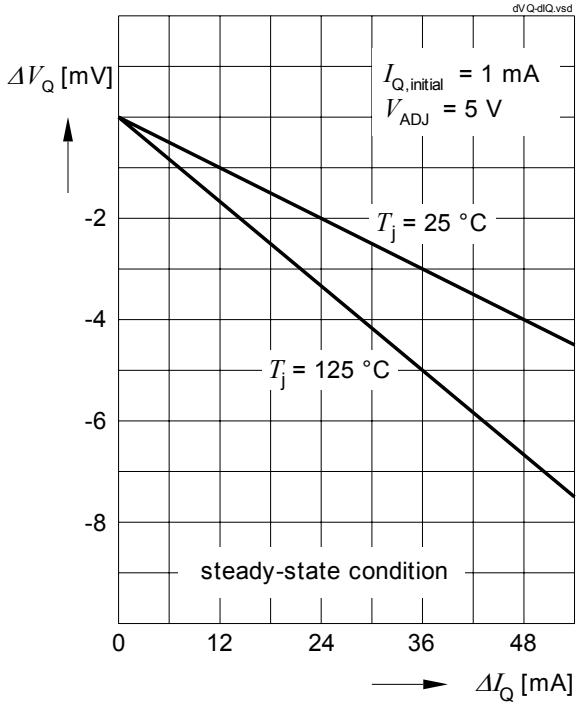
**Line Regulation d$V_{Q,line}$ vs.
Input Voltage Change dV_I)**



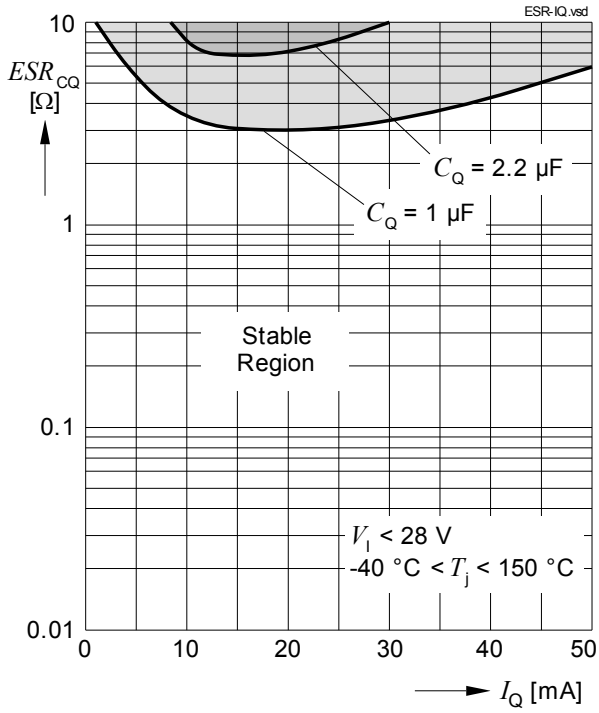
Typical Performance Characteristics Tracking Regulator

$V_{ADJ/EN}$ = 5 V (unless otherwise noted)

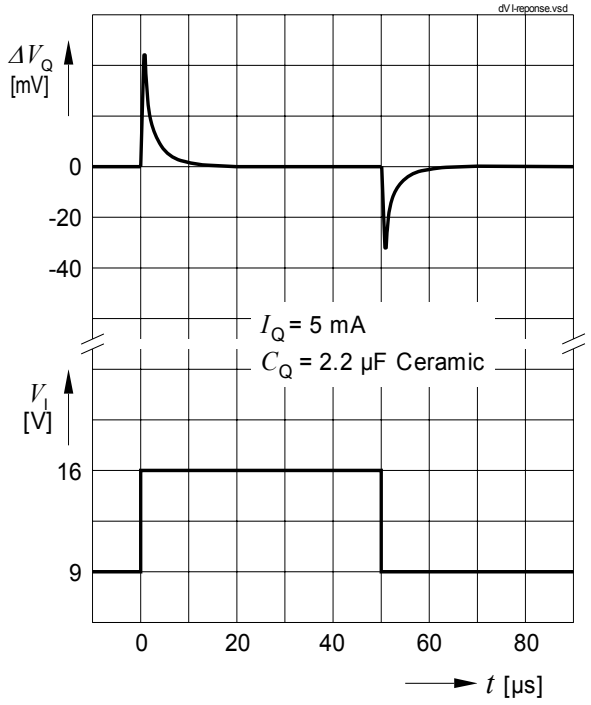
Load Regulation d$V_{Q,line}$ vs. Output Current Change dI_Q



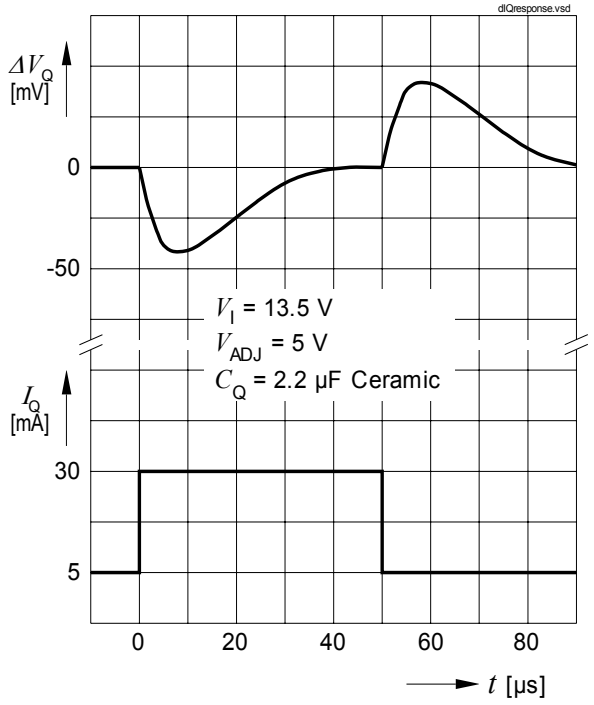
Output Capacitor Series Resistor ESR_{CQ} vs. Output Current I_Q



Line Transient Response



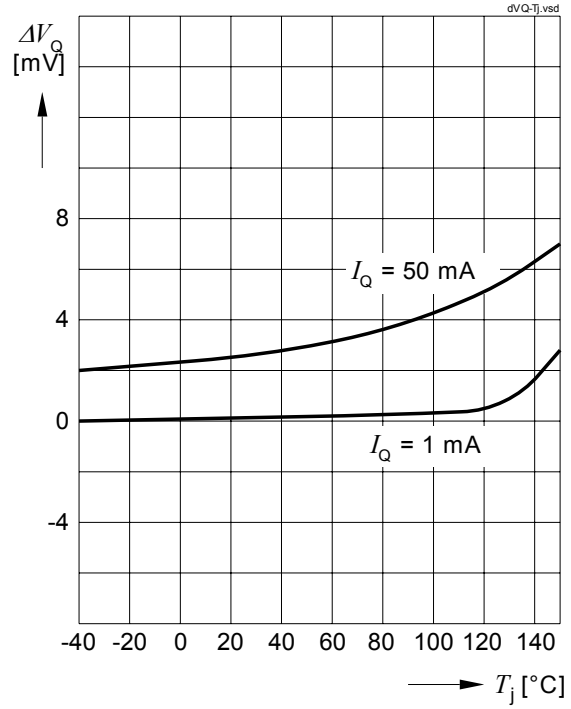
Load Transient Response



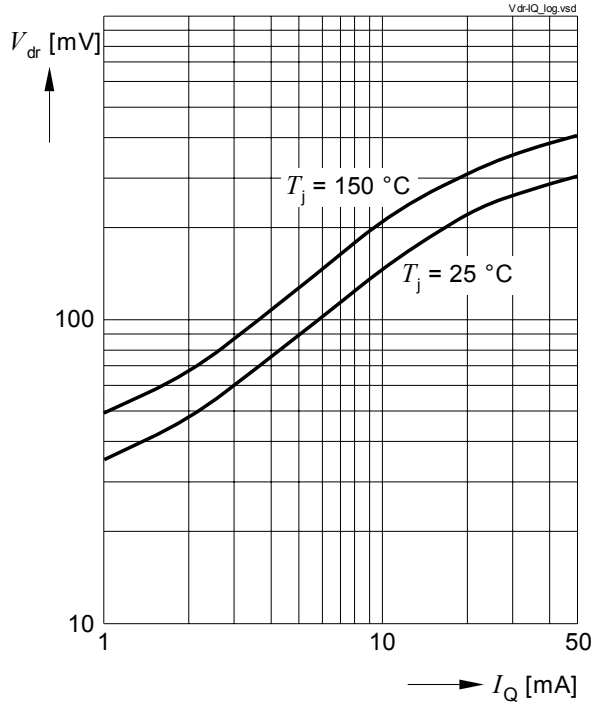
Typical Performance Characteristics Tracking Regulator

$V_{ADJ/EN}$ = 5 V (unless otherwise noted)

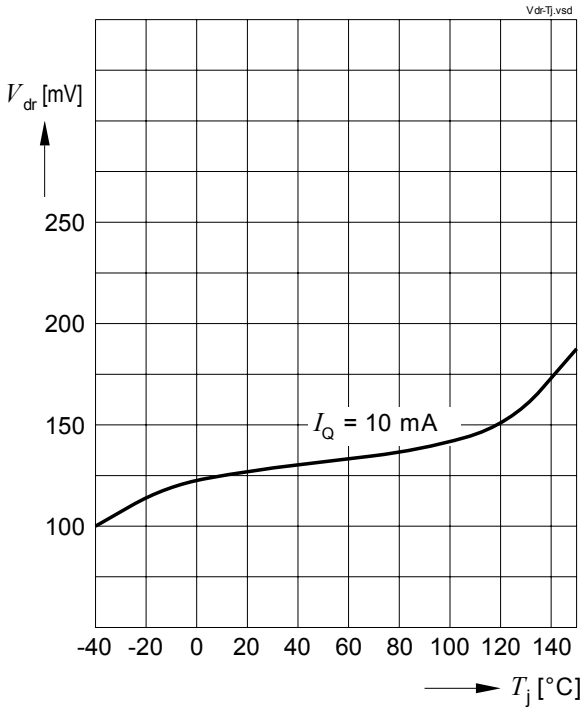
Tracking Accuracy ΔV_Q vs. Junction Temperature T_j



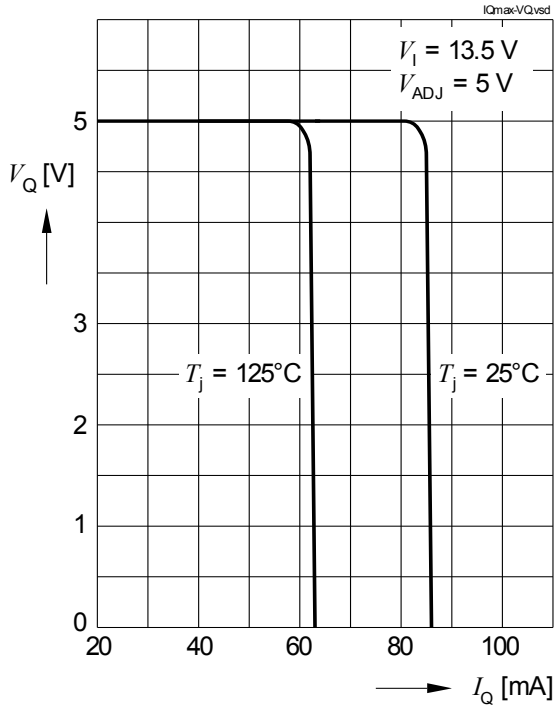
Dropout Voltage V_{dr} vs. Output Current I_Q



Dropout Voltage V_{dr} vs. Junction Temperature T_j



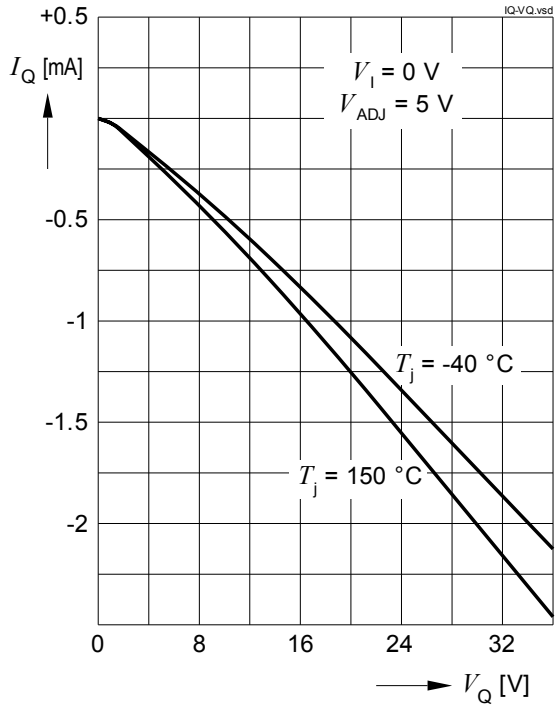
Output Current Limitation $I_{Q,max}$ vs. Output Voltage V_Q



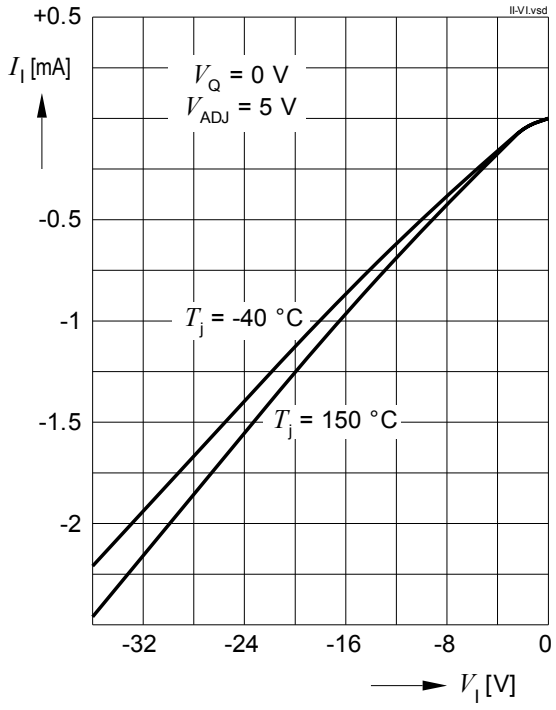
Typical Performance Characteristics Tracking Regulator

$V_{ADJ/EN}$ = 5 V (unless otherwise noted)

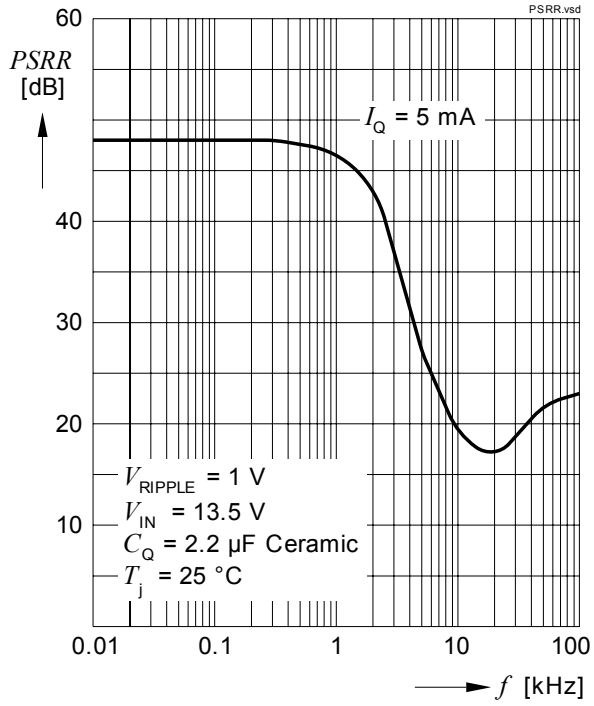
Reverse Output Current I_Q vs. Output Voltage V_Q



Reverse Current I_I vs. Input Voltage V_I



Power Supply Ripple Rejection *PSRR*



5.2 Current Consumption

Table 2 Electrical Characteristics Current Consumption

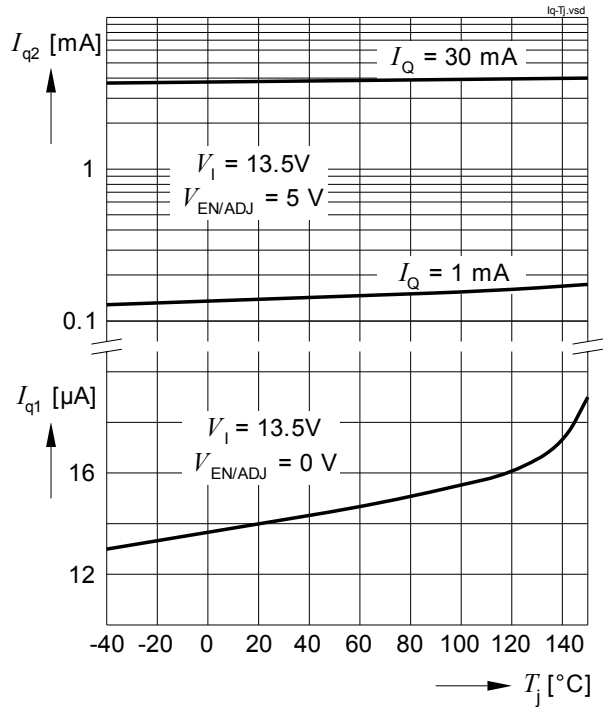
V_I = 13.5 V; $V_{ADJ/EN} \geq$ 2.5 V; -40 °C ≤ T_j ≤ 125 °C; all voltages with respect to ground (unless otherwise specified).

Pos.	Parameter	Symbol	Limit Values			Unit	Conditions
			Min.	Typ.	Max.		
5.2.1	Quiescent Current Stand-by Mode	I_{q1}	–	10	20	µA	$V_{ADJ/EN} \leq$ 0.4 V; $T_j \leq$ 85 °C
5.2.2	Current Consumption $I_q = I_I - I_Q$	I_{q2}	–	140	200	µA	$I_Q \leq$ 1 mA;
5.2.3			–	3	5	mA	$I_Q \leq$ 30 mA;
5.2.4	Current Consumption Dropout Region; $I_q = I_I - I_Q$	I_{q3}	–	1	2	mA	$V_{ADJ} = V_I$ = 5 V; I_Q = 0 mA

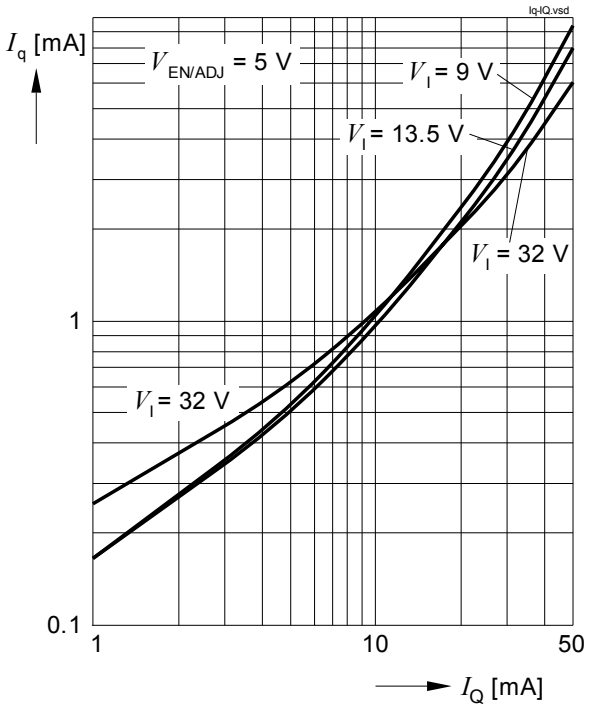
Typical Performance Characteristics Current Consumption

$V_{ADJ/EN}$ = 5 V (unless otherwise noted)

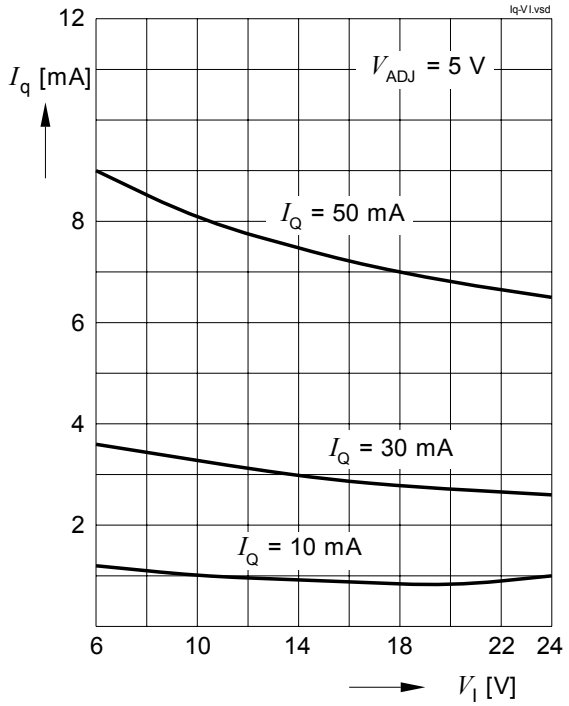
Current Consumption I_{q1}, I_{q2} vs. Junction Temperature T_j



Current Consumption I_{q2} vs. Output Current I_Q



Current Consumption I_{q2} vs.
Input Voltage V_I



5.3 Adjust / Enable Input

In order to reduce the quiescent current to a minimum, the IFX21401MB can be switched to stand-by mode by setting the adjust/enable input “ADJ/EN” to “low”.

Table 3 Electrical Characteristics Adjust / Enable

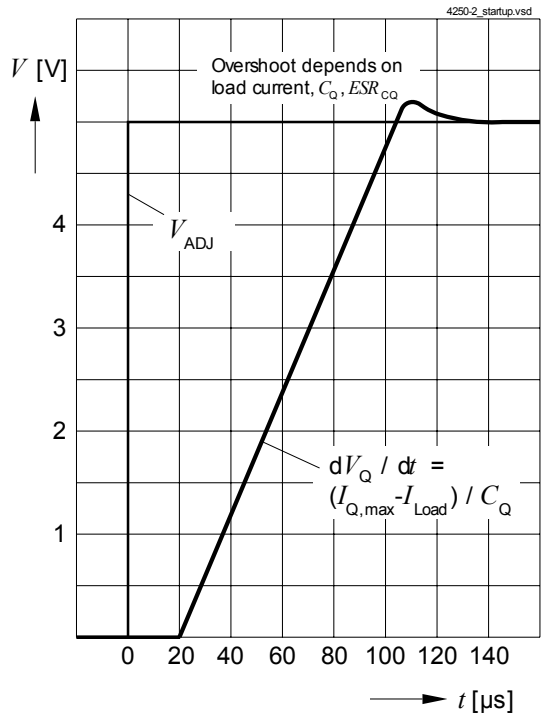
V_I = 13.5 V; $V_{ADJ} \geq$ 2.5 V; -40 °C ≤ T_j ≤ 125 °C;
all voltages with respect to ground, positive current flowing into pin (unless otherwise specified).

Pos.	Parameter	Symbol	Limit Values			Unit	Conditions
			Min.	Typ.	Max.		
5.3.1	Adjust / Enable Input Current	I_{ADJ}	–	0.1	0.5	µA	V_{ADJ} = 5 V;
5.3.2	Adjust / Enable Low Signal Valid	$V_{ADJ,low}$	–	–	0.4	V	V_Q = 0 V;
5.3.3	Adjust / Enable High Signal Valid (Tracking Region)	$V_{ADJ,high}$	2.5	–	36	V	$\lvert V_Q - V_{ADJ} \rvert < 25$ mV;

Typical Performance Characteristics Adjust / Enable Input

VADJ/EN = 5V (unless otherwise noted)

Startup Sequence



6 Package Outlines

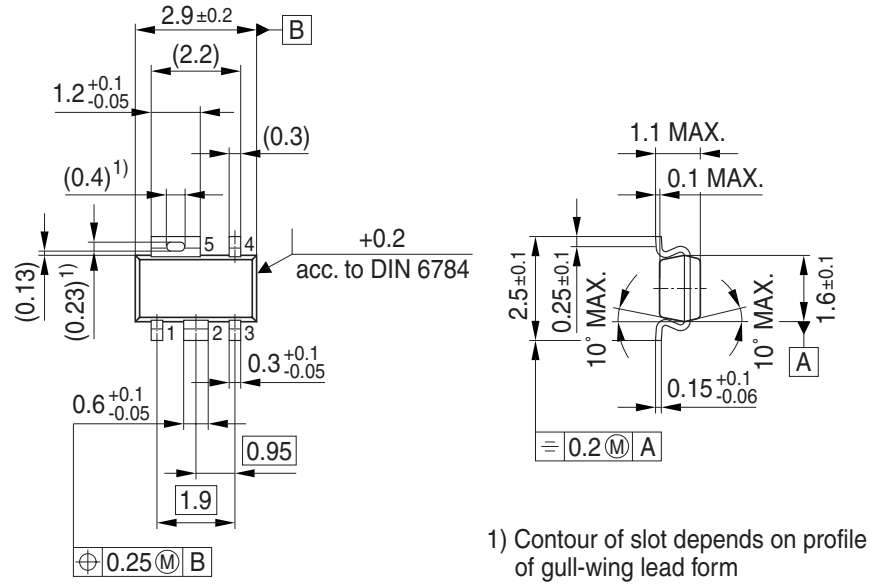


Figure 3 Outline PG-SCT595-5

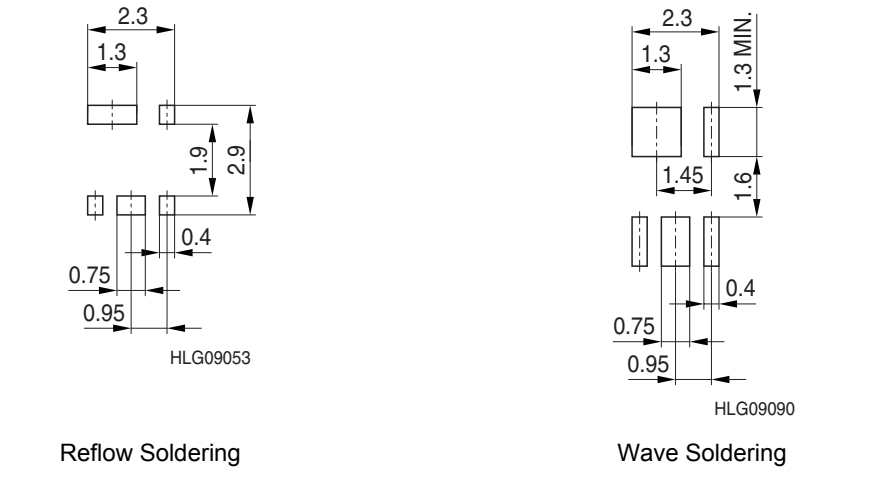


Figure 4 Footprint PG-SCT595-5

Green Product (RoHS compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

For further information on packages, please visit our website: **http://www.infineon.com/packages**

Dimensions in mm

7 Revision History

Revision	Date	Changes
1.01	2009-10-19	Coverpage changed Overview page: Inserted reference statement to TLE/TLF series.
1.0	2009-04-28	Initial Release

Edition 2009-10-19

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